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Details

E·XFI

Product Status	Active
Core Processor	HCS12X
Core Size	16-Bit
Speed	50MHz
Connectivity	CANbus, EBI/EMI, I ² C, IrDA, SCI, SPI
Peripherals	LVD, POR, PWM, WDT
Number of I/O	91
Program Memory Size	128KB (128K × 8)
Program Memory Type	FLASH
EEPROM Size	2K x 8
RAM Size	12K x 8
Voltage - Supply (Vcc/Vdd)	1.72V ~ 5.5V
Data Converters	A/D 16x12b
Oscillator Type	External
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	112-LQFP
Supplier Device Package	112-LQFP (20x20)
Purchase URL	https://www.e-xfl.com/pro/item?MUrl=&PartUrl=s912xeg128j2mal

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Chapter 2 Port Integration Module (S12XEPIMV1)

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208 MAPBGA	LQFP 144	LQFP 112	QFP ⁽¹⁾ 80	Pin	2nd Func.	3rd Func.	4th Func.	5th Func.
Т3	41			PC5	DATA13			
R5	42			PC6	DATA14			
N4	43			PC7	DATA15			
T4				PL3	TXD5			
T5	44	32		PH7	KWH7	SS2	TXD5	
P5				PL2	RXD5			
R6	45	33		PH6	KWH6	SCK2	RXD5	
N5				PL1	TXD4			
Т6	46	34		PH5	KWH5	MOSI2	TXD4	
P6				PL0	RXD4			
R7	47	35		PH4	KWH4	MISO2	RXD4	
T7	48	36	24	PE7	XCLKS	ECLKX2		
N6	49	37	25	PE6	MODB	TAGHI		
R8	50	38	26	PE5	MODA	TAGLO	RE	
P7	51	39	27	PE4	ECLK			
VSSX	52	40	28	VSSX2				
VDDX	53	41	29	VDDX2				
P8	54	42	30	RESET				
N8	55	43	31	VDDR				
N9	56	44	32	VSS3				
R9/T8	57	45	33	VSSPLL				
Т9	58	46	34	EXTAL				
T10	59	47	35	XTAL				
R10/T11	60	48	36	VDDPLL				
P9				PL7	TXD7			
N10	61	49		PH3	КШНЗ	SS1	TXD7	
P10				PL6	RXD7			
R11	62	50		PH2	KWH2	SCK1	RXD7	
T12				PL5	TXD6			

 Table 1-9. Pin-Out Summary (Sheet 3 of 7)



2.3.71 Port AD0 Data Direction Register 0 (DDR0AD0)



Figure 2-69. Port AD0 Data Direction Register 0 (DDR0AD0)

1. Read: Anytime. Write: Anytime.

Table 2-67. DDR0AD0 Register Field Descriptions

Field	Description
7-0 DDR0AD0	Port AD0 data direction— This register controls the data direction of pins 15 through 8. 1 Associated pin is configured as output. 0 Associated pin is configured as input.

NOTE

Due to internal synchronization circuits, it can take up to 2 bus clock cycles until the correct value is read on PT0AD0 registers, when changing the DDR0AD0 register.

NOTE

To use the digital input function on Port AD0 the ATD Digital Input Enable Register (ATD0DIEN1) has to be set to logic level "1".

2.3.72 Port AD0 Data Direction Register 1 (DDR1AD0)

Address 0x0273

Access: User read/write⁽¹⁾

	7	6	5	4	3	2	1	0
R W	DDR1AD07	DDR1AD06	DDR1AD05	DDR1AD04	DDR1AD03	DDR1AD02	DDR1AD01	DDR1AD00
Reset	0	0	0	0	0	0	0	0

Figure 2-70. Port AD0 Data Direction Register 1 (DDR1AD0)

1. Read: Anytime. Write: Anytime.



3.4.2.1.1 Expansion of the Local Address Map

Expansion of the CPU Local Address Map

The program page index register in MMC allows accessing up to 4 Mbyte of FLASH or ROM in the global memory map by using the eight page index bits to page 256 16 Kbyte blocks into the program page window located from address 0x8000 to address 0xBFFF in the local CPU memory map.

The page value for the program page window is stored in the PPAGE register. The value of the PPAGE register can be read or written by normal memory accesses as well as by the CALL and RTC instructions (see Section 3.5.1, "CALL and RTC Instructions).

Control registers, vector space and parts of the on-chip memories are located in unpaged portions of the 64-kilobyte local CPU address space.

The starting address of an interrupt service routine must be located in unpaged memory unless the user is certain that the PPAGE register will be set to the appropriate value when the service routine is called. However an interrupt service routine can call other routines that are in paged memory. The upper 16-kilobyte block of the local CPU memory space (0xC000-0xFFFF) is unpaged. It is recommended that all reset and interrupt vectors point to locations in this area or to the other unpaged sections of the local CPU memory map.

Table 3-16 summarizes mapping of the address bus in Flash/External space based on the address, the PPAGE register value and value of the ROMHM bit in the MMCCTL1 register.

Local CPU Address	ROMHM	External Access	Global Address
0x4000-0x7FFF	0	No	0x7F_4000 -0x7F_7FFF
	1	Yes	0x14_4000-0x14_7FFF
0x8000-0xBFFF	N/A	No ⁽¹⁾	0x40_0000-0x7F_FFFF
	N/A	Yes ¹	
0xC000-0xFFFF	N/A	No	0x7F_C000-0x7F_FFFF

Table 3-16. Global FLASH/ROM Allocated

1. The internal or the external bus is accessed based on the size of the memory resources implemented on-chip. Please refer to Figure 1-23 for further details.

The RAM page index register allows accessing up to 1 Mbyte –2 Kbytes of RAM in the global memory map by using the eight RPAGE index bits to page 4 Kbyte blocks into the RAM page window located in the local CPU memory space from address 0x1000 to address 0x1FFF. The EEPROM page index register EPAGE allows accessing up to 256 Kbytes of EEPROM in the system by using the eight EPAGE index bits to page 1 Kbyte blocks into the EEPROM page window located in the local CPU memory space from address 0x0800 to address 0x0800 to address 0x08FF.



5.4.2.1 Access Source Signals (ACC)

The access source can be determined from the external bus control signals ACC[2:0] as shown in Table 5-10.

ACC[2:0]	Access Description
000	Repetition of previous access cycle
001	CPU access
010	BDM external access
011	XGATE PRR access
100	No access ⁽¹⁾
101	CPU access error
110, 111	Reserved
1 Denotes also CPU acces	sses to BDM firmware and BDM registers (IOSTATy

Table 5-10. Determining Access Source from Control Signals

. Denotes also CPU accesses to BDM firmware and BDM registers (IQSTATx are 'XXXX' and $R\overline{W} = 1$ in these cases)

5.4.2.2 Instruction Queue Status Signals (IQSTAT)

The CPU instruction queue status (execution-start and data-movement information) is brought out as IQSTAT[3:0] signals. For decoding of the IQSTAT values, refer to the S12X_CPU section.

5.4.2.3 Internal Visibility Data (IVD)

Depending on the access size and alignment, either a word of read data is made visible on the address lines or only the related data byte will be presented in the ECLK low phase. For details refer to Table 5-11.

Invalid IVD are brought out in case of non-CPU read accesses.

Table 5-11	. IVD	Read	Data	Output
------------	-------	------	------	--------

Access	IVD[15:8]	IVD[7:0]
Word read of data at an even and even+1 address	ivd(even)	ivd(even+1)
Word read of data at an odd and odd+1 internal RAM address (misaligned)	ivd(odd+1)	ivd(odd)
Byte read of data at an even address	ivd(even)	addr[7:0] (rep.)
Byte read of data at an odd address	addr[15:8] (rep.)	ivd(odd)

5.4.2.4 Emulation Modes Timing

A bus access lasts 1 ECLK cycle. In case of a stretched external access (emulation expanded mode), up to an infinite amount of ECLK cycles may be added. ADDRx values will only be shown in ECLK high phases, while ACCx, IQSTATx, and IVDx values will only be presented in ECLK low phases.

Based on this multiplex timing, ACCx are only shown in the current (first) access cycle. IQSTATx and (for read accesses) IVDx follow in the next cycle. If the access takes more than one bus cycle, ACCx display NULL (0x000) in the second and all following cycles of the access. IQSTATx display NULL (0x0000) from the third until one cycle after the access to indicate continuation.



6.3 Memory Map and Register Definition

This section provides a detailed description of all registers accessible in the XINT module.

6.3.1 Module Memory Map

Table 6-3 gives an overview over all XINT module registers.

Table 6-3.	XINT	Memory	Мар
------------	------	--------	-----

Address	Use	Access
0x0120	RESERVED	—
0x0121	Interrupt Vector Base Register (IVBR)	R/W
0x0122-0x0125	RESERVED	—
0x0126	XGATE Interrupt Priority Configuration Register (INT_XGPRIO)	R/W
0x0127	Interrupt Request Configuration Address Register (INT_CFADDR)	R/W
0x0128	Interrupt Request Configuration Data Register 0 (INT_CFDATA0)	R/W
0x0129	Interrupt Request Configuration Data Register 1 (INT_CFDATA1)	R/W
0x012A	Interrupt Request Configuration Data Register 2 (INT_CFDATA2	R/W
0x012B	Interrupt Request Configuration Data Register 3 (INT_CFDATA3)	R/W
0x012C	Interrupt Request Configuration Data Register 4 (INT_CFDATA4)	R/W
0x012D	Interrupt Request Configuration Data Register 5 (INT_CFDATA5)	R/W
0x012E	Interrupt Request Configuration Data Register 6 (INT_CFDATA6)	R/W
0x012F	Interrupt Request Configuration Data Register 7 (INT_CFDATA7)	R/W



7.1.2.3 Low-Power Modes

The BDM can be used until all bus masters (e.g., CPU or XGATE or others depending on which masters are available on the SOC) are in stop mode. When CPU is in a low power mode (wait or stop mode) all BDM firmware commands as well as the hardware BACKGROUND command can not be used respectively are ignored. In this case the CPU can not enter BDM active mode, and only hardware read and write commands are available. Also the CPU can not enter a low power mode during BDM active mode.

If all bus masters are in stop mode, the BDM clocks are stopped as well. When BDM clocks are disabled and one of the bus masters exits from stop mode the BDM clocks will restart and BDM will have a soft reset (clearing the instruction register, any command in progress and disable the ACK function). The BDM is now ready to receive a new command.

7.1.3 Block Diagram

A block diagram of the BDM is shown in Figure 7-1.



Figure 7-1. BDM Block Diagram

7.2 External Signal Description

A single-wire interface pin called the background debug interface (BKGD) pin is used to communicate with the BDM system. During reset, this pin is a mode select input which selects between normal and special modes of operation. After reset, this pin becomes the dedicated serial interface pin for the background debug mode.



CMP

Compare



Operation

 $\begin{array}{ll} RS1 - RS2 & \Rightarrow NONE \mbox{ (translates to SUB R0, RS1, RS2)} \\ RD - IMM16 & \Rightarrow NONE \mbox{ (translates to CMPL RD, #IMM16[7:0]; CPCH RD, #IMM16[15:8])} \end{array}$

Subtracts two 16 bit values and discards the result.

CCR Effects

Ν	Ζ	V	С
Δ	Δ	Δ	Δ

- N: Set if bit 15 of the result is set; cleared otherwise.
- Z: Set if the result is \$0000; cleared otherwise.
- V: Set if a two's complement overflow resulted from the operation; cleared otherwise. RS1[15] & RS2[15] & result[15] | RS1[15] & RS2[15] & result[15] RD[15] & IMM16[15] & result[15] | RD[15] & IMM16[15] & result[15]
- C: Set if there is a carry from the bit 15 of the result; cleared otherwise. RS1[15] & RS2[15] | RS1[15] & result[15] | RS2[15] & result[15] RD[15] & IMM16[15] | RD[15] & result[15] | IMM16[15] & result[15]

Code and CPU Cycles

Source Form	Address Mode		Machine Code								Cycles			
CMP RS1, RS2	TRI	0	0 0 0 1 1 0 0 0 RS1 RS2 0 0		0	Р								
CMP RS, #IMM16	IMM8	1	1	0	1	0	RS			IMM16[7:0]				Р
	IMM8	1	1	0	1	1	RS			IM	M16[15:8]			Р





Logical OR Immediate 8 bit Constant (Low Byte)



Operation

 $RD.L \mid IMM8 \Rightarrow RD.L$

Performs a bit wise logical OR between the low byte of register RD and an immediate 8 bit constant and stores the result in the destination register RD.L. The high byte of RD is not affected.

CCR Effects

Ν	z	v	С
Δ	Δ	0	

- N: Set if bit 7 of the result is set; cleared otherwise.
- Z: Set if the 8 bit result is \$00; cleared otherwise.
- V: 0; cleared.
- C: Not affected.

Code and CPU Cycles

Source Form	Address Mode		Machine Code						Cycles
ORL RD, #IMM8	IMM8	1	0	1	0	0	RD	IMM8	Р



14.3.2.12 Main Timer Interrupt Flag 1 (TFLG1)



Read: Anytime

Write used in the flag clearing mechanism. Writing a one to the flag clears the flag. Writing a zero will not affect the current status of the bit.

NOTE

When TFFCA = 1, the flags cannot be cleared via the normal flag clearing mechanism (writing a one to the flag). Reference Section 14.3.2.6, "Timer System Control Register 1 (TSCR1)".

All bits reset to zero.

TFLG1 indicates when interrupt conditions have occurred. The flags can be cleared via the normal flag clearing mechanism (writing a one to the flag) or via the fast flag clearing mechanism (reference TFFCA bit in Section 14.3.2.6, "Timer System Control Register 1 (TSCR1)").

Use of the TFMOD bit in the ICSYS register in conjunction with the use of the ICOVW register allows a timer interrupt to be generated after capturing two values in the capture and holding registers, instead of generating an interrupt for every capture.

Table 14-17. TFLG1 Field Descriptions

Field	Description
7:0 C[7:0]F	Input Capture/Output Compare Channel "x" Flag — A CxF flag is set when a corresponding input capture or output compare is detected. C0F can also be set by 16-bit Pulse Accumulator B (PACB). C3F–C0F can also be set by 8-bit pulse accumulators PAC3–PAC0.
	If the delay counter is enabled, the CxF flag will not be set until after the delay.

14.3.2.13 Main Timer Interrupt Flag 2 (TFLG2)



Figure 14-19. Main Timer Interrupt Flag 2 (TFLG2)

Read: Anytime

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16.4.3.1 Protocol Violation Protection

The MSCAN protects the user from accidentally violating the CAN protocol through programming errors. The protection logic implements the following features:

- The receive and transmit error counters cannot be written or otherwise manipulated.
- All registers which control the configuration of the MSCAN cannot be modified while the MSCAN is on-line. The MSCAN has to be in Initialization Mode. The corresponding INITRQ/INITAK handshake bits in the CANCTL0/CANCTL1 registers (see Section 16.3.2.1, "MSCAN Control Register 0 (CANCTL0)") serve as a lock to protect the following registers:
 - MSCAN control 1 register (CANCTL1)
 - MSCAN bus timing registers 0 and 1 (CANBTR0, CANBTR1)
 - MSCAN identifier acceptance control register (CANIDAC)
 - MSCAN identifier acceptance registers (CANIDAR0–CANIDAR7)
 - MSCAN identifier mask registers (CANIDMR0–CANIDMR7)
- The TXCAN is immediately forced to a recessive state when the MSCAN goes into the power down mode or initialization mode (see Section 16.4.5.6, "MSCAN Power Down Mode," and Section 16.4.4.5, "MSCAN Initialization Mode").
- The MSCAN enable bit (CANE) is writable only once in normal system operation modes, which provides further protection against inadvertently disabling the MSCAN.

16.4.3.2 Clock System

Figure 16-43 shows the structure of the MSCAN clock generation circuitry.



Figure 16-43. MSCAN Clocking Scheme

The clock source bit (CLKSRC) in the CANCTL1 register (16.3.2.2/16-613) defines whether the internal CANCLK is connected to the output of a crystal oscillator (oscillator clock) or to the bus clock.

The clock source has to be chosen such that the tight oscillator tolerance requirements (up to 0.4%) of the CAN protocol are met. Additionally, for high CAN bus rates (1 Mbps), a 45% to 55% duty cycle of the clock is required.

If the bus clock is generated from a PLL, it is recommended to select the oscillator clock rather than the bus clock due to jitter considerations, especially at the faster CAN bus rates.





19.4 Functional Description

19.4.1 PWM Clock Select

There are four available clocks: clock A, clock B, clock SA (scaled A), and clock SB (scaled B). These four clocks are based on the bus clock.

Clock A and B can be software selected to be 1, 1/2, 1/4, 1/8,..., 1/64, 1/128 times the bus clock. Clock SA uses clock A as an input and divides it further with a reloadable counter. Similarly, clock SB uses clock B as an input and divides it further with a reloadable counter. The rates available for clock SA are software selectable to be clock A divided by 2, 4, 6, 8,..., or 512 in increments of divide by 2. Similar rates are available for clock SB. Each PWM channel has the capability of selecting one of two clocks, either the pre-scaled clock (clock A or B) or the scaled clock (clock SA or SB).

The block diagram in Figure 19-18 shows the four different clocks and how the scaled clocks are created.

19.4.1.1 Prescale

The input clock to the PWM prescaler is the bus clock. It can be disabled whenever the part is in freeze mode by setting the PFRZ bit in the PWMCTL register. If this bit is set, whenever the MCU is in freeze mode (freeze mode signal active) the input clock to the prescaler is disabled. This is useful for emulation in order to freeze the PWM. The input clock can also be disabled when all eight PWM channels are disabled (PWME7-0 = 0). This is useful for reducing power by disabling the prescale counter.

Clock A and clock B are scaled values of the input clock. The value is software selectable for both clock A and clock B and has options of 1, 1/2, 1/4, 1/8, 1/16, 1/32, 1/64, or 1/128 times the bus clock. The value selected for clock A is determined by the PCKA2, PCKA1, PCKA0 bits in the PWMPRCLK register. The value selected for clock B is determined by the PCKB2, PCKB1, PCKB0 bits also in the PWMPRCLK register.

19.4.1.2 Clock Scale

The scaled A clock uses clock A as an input and divides it further with a user programmable value and then divides this by 2. The scaled B clock uses clock B as an input and divides it further with a user programmable value and then divides this by 2. The rates available for clock SA are software selectable to be clock A divided by 2, 4, 6, 8,..., or 512 in increments of divide by 2. Similar rates are available for clock SB.



20.4.6 Receiver



Figure 20-20. SCI Receiver Block Diagram

20.4.6.1 Receiver Character Length

The SCI receiver can accommodate either 8-bit or 9-bit data characters. The state of the M bit in SCI control register 1 (SCICR1) determines the length of data characters. When receiving 9-bit data, bit R8 in SCI data register high (SCIDRH) is the ninth bit (bit 8).

20.4.6.2 Character Reception

During an SCI reception, the receive shift register shifts a frame in from the RXD pin. The SCI data register is the read-only buffer between the internal data bus and the receive shift register.

After a complete frame shifts into the receive shift register, the data portion of the frame transfers to the SCI data register. The receive data register full flag, RDRF, in SCI status register 1 (SCISR1) becomes set,



Chapter 21 Serial Peripheral Interface (S12SPIV5)

Table 21-1. Revision History

Revision Number	Revision Date	Sections Affected	Description of Changes
V05.00	24 Mar 2005	21.3.2/21-765	- Added 16-bit transfer width feature.

21.1 Introduction

The SPI module allows a duplex, synchronous, serial communication between the MCU and peripheral devices. Software can poll the SPI status flags or the SPI operation can be interrupt driven.

21.1.1 Glossary of Terms

SPI	Serial Peripheral Interface
SS	Slave Select
SCK	Serial Clock
MOSI	Master Output, Slave Input
MISO	Master Input, Slave Output
MOMI	Master Output, Master Input
SISO	Slave Input, Slave Output

21.1.2 Features

The SPI includes these distinctive features:

- Master mode and slave mode
- Selectable 8 or 16-bit transfer width
- Bidirectional mode
- Slave select output
- Mode fault error flag with CPU interrupt capability
- Double-buffered data register
- Serial clock with programmable polarity and phase
- Control of SPI operation during wait mode

21.1.3 Modes of Operation

The SPI functions in three modes: run, wait, and stop.



Write: Has no meaning or effect in the normal mode; only writable in special modes (test_mode = 1).

The period of the first count after a write to the TCNT registers may be a different size because the write is not synchronized with the prescaler clock.

22.3.2.6 Timer System Control Register 1 (TSCR1)

Module Base + 0x0006

	7	6	5	4	3	2	1	0
R			TOED7		DDNIT	0	0	0
w		ISVVAI	ISFNZ	IFFCA				
Reset	0	0	0	0	0	0	0	0
	= Unimplemented or Reserved							

Figure 22-12. Timer System Control Register 1 (TSCR1)

Read: Anytime

Write: Anytime

Table 22-6. TSCR	1 Field Descriptions
------------------	----------------------

Field	Description
7 TEN	Timer Enable 0 Disables the main timer, including the counter. Can be used for reducing power consumption. 1 Allows the timer to function normally. If for any reason the timer is not active, there is no ÷64 clock for the pulse accumulator because the ÷64 is generated by the timer prescaler.
6 TSWAI	 Timer Module Stops While in Wait Allows the timer module to continue running during wait. Disables the timer module when the MCU is in the wait mode. Timer interrupts cannot be used to get the MCU out of wait. TSWAI also affects pulse accumulator.
5 TSFRZ	Timer Stops While in Freeze Mode0 Allows the timer counter to continue running while in freeze mode.1 Disables the timer counter whenever the MCU is in freeze mode. This is useful for emulation.TSFRZ does not stop the pulse accumulator.



22.3.2.18 Output Compare Pin Disconnect Register(OCPD)



All bits reset to zero.

Table 22-22. OCPD Field Des	cription
-----------------------------	----------

Field	Description
OCPD[7:0}	 Output Compare Pin Disconnect Bits Enables the timer channel port. Ouptut Compare action will occur on the channel pin. These bits do not affect the input capture or pulse accumulator functions Disables the timer channel port. Output Compare action will not occur on the channel pin, but the output compare flag still become set .

22.3.2.19 Precision Timer Prescaler Select Register (PTPSR)

Module Base + 0x002E



Figure 22-29. Precision Timer Prescaler Select Register (PTPSR)

Read: Anytime

Write: Anytime

All bits reset to zero.



Register	Error Bit	Error Condition
FSTAT	ACCERR	Set if CCOBIX[2:0] != 000 at command launch
		Set if command not available in current mode (see Table 24-30)
	FPVIOL	None
	MGSTAT1	None
	MGSTAT0	None
FERSTAT	EPVIOLIF	None

 Table 24-74. EEPROM Emulation Query Command Error Handling

24.4.2.21 Partition D-Flash Command

The Partition D-Flash command allows the user to allocate sectors within the D-Flash block for applications and a partition within the buffer RAM for EEPROM access. The D-Flash block consists of 32 sectors with 256 bytes per sector. The Erase All Blocks command must be run prior to launching the Partition D-Flash command.

Table 24-75. Partition D-Flash Command FCCOB Requirements

CCOBIX[2:0]	FCCOB Parameters		
000	0x20	Not required	
001	Number of 256 byte sectors for the D-Flash user partition (DFPART)		
010	Number of 256 byte sectors for buffer RAM EEE partition (ERPART)		

Upon clearing CCIF to launch the Partition D-Flash command, the following actions are taken to define a partition within the D-Flash block for direct access (DFPART) and a partition within the buffer RAM for EEE use (ERPART):

- Validate the DFPART and ERPART values provided:
 - DFPART <= 128 (maximum number of 256 byte sectors in D-Flash block)
 - ERPART <= 8 (maximum number of 256 byte sectors in buffer RAM)
 - If ERPART > 0, 128 DFPART >= 12 (minimum number of 256 byte sectors in the D-Flash block required to support EEE)
 - If ERPART > 0, ((128-DFPART)/ERPART) >= 8 (minimum ratio of D-Flash EEE space to buffer RAM EEE space to support EEE)
- Erase verify the D-Flash block and the EEE nonvolatile information register
- Program DFPART to the EEE nonvolatile information register at global address 0x12_0000 (see Table 24-7)
- Program a duplicate DFPART to the EEE nonvolatile information register at global address 0x12_0002 (see Table 24-7)

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- Program a duplicate DFPART to the EEE nonvolatile information register at global address 0x12_0002 (see Table 29-7)
- Program ERPART to the EEE nonvolatile information register at global address 0x12_0004 (see Table 29-7)
- Program a duplicate ERPART to the EEE nonvolatile information register at global address 0x12_0006 (see Table 29-7)

The D-Flash user partition will start at global address $0x10_{0000}$. The buffer RAM EEE partition will end at global address $0x13_{FFFF}$. After the Partition D-Flash operation has completed, the CCIF flag will set.

Running the Partition D-Flash command a second time will result in the ACCERR bit within the FSTAT register being set. The data value written corresponds to the number of 256 byte sectors allocated for either direct D-Flash access (DFPART) or buffer RAM EEE access (ERPART).

Register	Error Bit	Error Condition
FSTAT	ACCERR	Set if CCOBIX[2:0] != 010 at command launch
		Set if a Load Data Field command sequence is currently active
		Set if command not available in current mode (see Table 29-30)
		Set if partitions have already been defined
		Set if an invalid DFPART or ERPART selection is supplied
	FPVIOL	None
	MGSTAT1	Set if any errors have been encountered during the read
	MGSTAT0	Set if any non-correctable errors have been encountered during the read
FERSTAT	EPVIOLIF	None

Table 29-78. Partition D-Flash Command Error Handling



A.6.1.2 SRAM Data Retention

Provided an appropriate external reset signal is applied to the MCU, preventing the CPU from executing code when V_{DD35} is out of specification limits, the SRAM contents integrity is guaranteed if after the reset the PORF bit in the CRG flags register has not been set.

A.6.1.3 External Reset

When external reset is asserted for a time greater than PW_{RSTL} the CRG module generates an internal reset, and the CPU starts fetching the reset vector without doing a clock quality check, if there was an oscillation before reset.

A.6.1.4 Stop Recovery

Out of stop the controller can be woken up by an external interrupt. A clock quality check as after POR is performed before releasing the clocks to the system.

If the MCU is woken-up by an interrupt and the fast wake-up feature is enabled (FSTWKP = 1 and SCME = 1), the system will resume operation in self-clock mode after t_{fws} .

A.6.1.5 Pseudo Stop and Wait Recovery

The recovery from pseudo stop and wait is essentially the same since the oscillator is not stopped in both modes. The controller can be woken up by internal or external interrupts. After t_{wrs} the CPU starts fetching the interrupt vector.